TRANSMITTAL

Electronic Version v1.1

Stylesheet Version v1.1.0

Title of
Invention

Printed Circuit Board with Isolated Metallic Substrate Comprising an Integrated Cooling System

Application Number:

Date:

First Named Applicant:

Carles Borrego Bel

Confirmation Number:

Attorney Docket Number: 8134ES

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Submitted By:	Elec. Sign.	Sign. Capacity
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Documents being submitted:	Files
us-fee-sheet	8134ES-usfees.xml
	us-fee-sheet.xsl
	us-fee-sheet.dtd
us-ids	8134ES-usidst.xml
	us-ids.dtd
	us-ids.xsl
us-request	8134ES-usrequ.xml
·	us-request.dtd
	us-request.xsl
application-body	8134ES-trans.xml
,	us-application-body.xsl
	application-body.dtd
	wipo.ent
	mathml2.dtd
	mathml2-qname-1.mod
	isoamsa.ent
	isoamsb.ent
	isoamsc.ent
	isoamsn.ent
	isoamso.ent
	isoamsr.ent
	isogrk3.ent
	isomfrk.ent
	isomopf.ent
	isomscr.ent
	isotech.ent
	isobox.ent
	isocyr1.ent
	isocyr2.ent
	isodia.ent
	isolat1.ent
	isolat2.ent
	isonum.ent
	isopub.ent
	mmlextra.ent
	mmlalias.ent
	soextblx.dtd
	8134ES_Figs1-3.TIF
	8134ES_Figs4-7.TIF
Comments	